TOSHIBA TLP762J

**TENTATIVE** 

TOSHIBA PHOTOCOUPLER GaAs IRED + PHOTO-TRIAC

# **TLP762**J

OFFICE MACHINE
HOUSEHOLD USE EQUIPMENT
TRIAC DRIVER
SOLID STATE RELAY

The TOSHIBA TLP762J consists of a GaAs infrared LED optically coupled to a photo-triac in a 6 lead plastic DIP.

Peak Off-State Voltage : 600V (MIN.)
 Trigger LED Current : 10mA (MAX.)
 On-State Current : 100mA (MAX.)
 Isolation Voltage : 4000Vrms (MIN.)

• UL Recognized : UL1577, File No. E67349

• BSI Approved : BS EN60065 : 1994, Certificate No. 7831

BS EN60950 : 1992, Certificate No. 7832

• SEMKO Approved : SS EN60065 (EN60065, 1993)

SS EN60950 (EN60950, 1992) SS EN60335 (EN60335, 1988)

Certificate No. 9522145

• Option (D4) type

 $VDE\ Approved \qquad \qquad :\ DIN\ VDE 0884 \, / \, 06.92$ 

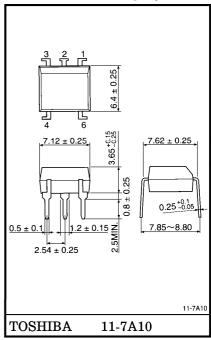
Certificate No. 91803

Maximum Operating Insulation Voltage: 890VpK Highest Permissible Over Voltage: 6000VpK

(Note) When a VDE0884 approved type is needed, please designate the "Option (D4)"

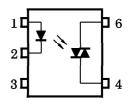
			7.62mm pich TLP762J type		10.16mm pich TLP762JF type		
•	Creepage Distance	:	7.0mm (Min.)	Ī	8.0mm (Min.)		
	Clearance	:	7.0mm (Min.)		8.0mm (Min.)		
	Internal Creepage Path	:	4.0mm (Min.)		4.0mm (Min.)		
	Insulation Thickness	:	0.5mm (Min.)		0.5mm (Min.)		

Unit in mm



Weight: 0.42g

PIN CONFIGURATION (TOP VIEW)



1 : ANODE 2 : CATHODE 3 : N.C. 4 : TRIAC 1 6 : TRIAC 2

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## MAXIMUM RATINGS (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	RATING	UNIT		
	Forward Current	$I_{\mathbf{F}}$	50	mA		
ED	Forward Current Derating (Ta≥	⊿I <sub>F</sub> /°C	-0.7	mA/°C		
	Peak Forward Current (100 µs pu	$I_{\mathrm{FP}}$	1	Α		
ı	Reverse Voltage	$v_{ m R}$	5	V		
	Junction Temperature	Тј	125	°C		
	Off-State Output Terminal Volta	$v_{ m DRM}$	600	V		
	On-State RMS Current	Ta = 25°C	I <sub>T</sub> (RMS)	100	mA	
DETECTOR		Ta=70°C		50		
	On-State Current Derating (Ta=	$\Delta I_{\mathrm{T}}/^{\circ}\mathrm{C}$	-1.1	mA/°C		
	Peak On-State Current (100 µs p	$I_{ ext{TP}}$	2	Α		
	Peak Nonrepetitive Surge Current (PW=10ms, DC=10%)	$I_{TSM}$	1.2	A		
	Junction Temperature	$T_{\mathbf{j}}$	115	°C		
Storage Temperature Range			$\mathrm{T}_{\mathrm{stg}}$	-55~125	°C	
Operating Temperature Range			$T_{ m opr}$	-40~100	°C	
Lead Soldering Temperature (10s)			$T_{sol}$	260	$^{\circ}\mathrm{C}$	
Isol	Isolation Voltage (AC, 1 min., R.H.≤60%)			4000	Vrms	

#### RECOMMENDED OPERATING CONDITIONS

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply Voltage	$v_{AC}$	1		240	Vac
Forward Current	${ m I_F}$	15	20	25	mA
Peak On-State Current	$I_{\mathrm{TP}}$	_	_	1	A
Operating Temperature	$T_{ m opr}$	-25	_	85	°C

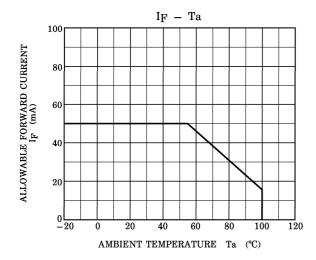
## INDIVIDUAL ELECTRICAL CHARACTERISTICS (Ta = 25°C)

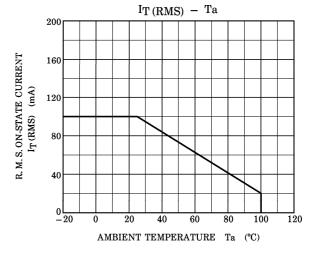
	CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
D	Forward Voltage	$V_{\mathbf{F}}$	$I_{ m F} = 10 { m mA}$	1.0	1.15	1.3	V
LE)	Reverse Current	$I_{\mathbf{R}}$	$V_R = 5V$	I	I	10	$\mu$ A
	Capacitance	$c_{T}$	V=0, f=1MHz	ı	30	_	рF
	Peak Off-State Current	$I_{ m DRM}$	$V_{ m DRM} = 600 V$		10	1000	nA
DETECTOR	Peak On-State Voltage	$V_{ extbf{TM}}$	$I_{TM} = 100 mA$	ı	1.7	3.0	V
	Holding Current	$I_{ m H}$			0.6	_	mA
	Critical Rate of Rise of Off-State Voltage	dv / dt	Vin=240V, Ta=85°C	1	500	_	$V/\mu$ s
	Critical Rate of Rise of Commutating Voltage	dv / dt (C)	I <sub>T</sub> =15mA Vin=60Vrms	_	0.2	_	V/μs

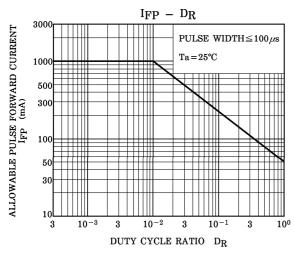
## COUPLED ELECTRICAL CHARACTERISTICS (Ta = 25°C)

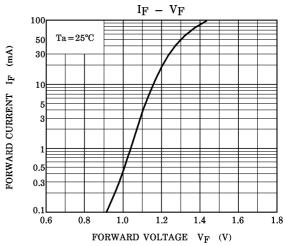
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT	
Trigger LED Current	$I_{\mathrm{FT}}$	$V_{\mathrm{T}}=6V$	_		10	mA	
Capacitance (Input to Output)	$c_{S}$	$V_S=0$ , $f=1MHz$	_	0.8	I	рF	
Isolation Resistance	$R_{\mathbf{S}}$	$V_S = 500V$	$1 \times 10^{12}$	$10^{14}$	ı	Ω	
	$BV_{\mathbf{S}}$	AC, 1 minute	4000	l	ı	Vrms	
Isolation Voltage		AC, 1 second, in oil	_	10000			
		DC, 1 minute, in oil	_	10000		$v_{dc}$	

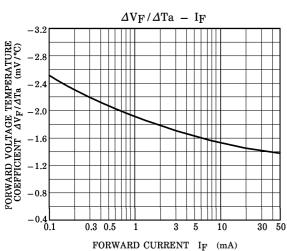
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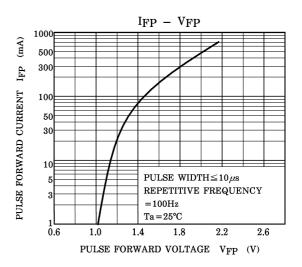












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